NPN Silicon Epitaxial Transistor

This NPN Silicon Epitaxial Transistor is designed for use in low voltage, high current applications. The device is housed in the SOT-223 package, which is designed for medium power surface mount applications.

Features

- High Current: $I_C = 1.0 \text{ A}$
- The SOT-223 Package Can Be Soldered Using Wave or Reflow
- SOT-223 package ensures level mounting, resulting in improved thermal conduction, and allows visual inspection of soldered joints.
 The formed leads absorb thermal stress during soldering, eliminating the possibility of damage to the die
- The PNP Complement is BCP69T1
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	20	Vdc
Collector-Base Voltage	V _{CBO}	25	Vdc
Emitter-Base Voltage	V _{EBO}	5.0	Vdc
Collector Current	Ic	1.0	Adc
Total Power Dissipation @ T _A = 25°C (Note 1)	P _D	1.5	W
Derate above 25°C		12	mW/°C
Operating and Storage Temperature Range	T _J , T _{stg}	- 65 to 150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient (Surface Mounted)	$R_{\theta JA}$	83.3	°C/W
Lead Temperature for Soldering, 0.0625 in from case	T_L	260	°C
Time in Solder Bath		10	Sec

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

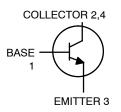
Device mounted on a glass epoxy printed circuit board 1.575 in. x 1.575 in. x 0.059 in.; mounting pad for the collector lead min. 0.93 sq. in.



ON Semiconductor®

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MEDIUM POWER NPN SILICON HIGH CURRENT TRANSISTOR SURFACE MOUNT



MARKING DIAGRAM



SOT-223 CASE 318E STYLE 1



CA = Specific Device Code A = Assembly Location

Y = Year
W = Work Week
Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
BCP68T1G	SOT-223 (Pb-Free)	1000/Tape & Reel
BCP68T3G	SOT-223 (Pb-Free)	4000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristics	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Collector-Emitter Breakdown Voltage ($I_C = 100 \mu Adc, I_E = 0$)	V _{(BR)CES}	25	-	-	Vdc	
Collector-Emitter Breakdown Voltage (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	20	-	-	Vdc	
Emitter-Base Breakdown Voltage ($I_E = 10 \mu Adc, I_C = 0$)	V _{(BR)EBO}	5.0	-	-	Vdc	
Collector-Base Cutoff Current (V _{CB} = 25 Vdc, I _E = 0)	I _{CBO}	-	-	10	μAdc	
Emitter-Base Cutoff Current (V _{EB} = 5.0 Vdc, I _C = 0)	I _{EBO}	-	-	10	μ A dc	
ON CHARACTERISTICS						
DC Current Gain ($I_C = 5.0$ mAdc, $V_{CE} = 10$ Vdc) ($I_C = 500$ mAdc, $V_{CE} = 1.0$ Vdc) ($I_C = 1.0$ Adc, $V_{CE} = 1.0$ Vdc)	h _{FE}	50 85 60	- - -	- 375 -	-	
Collector-Emitter Saturation Voltage (I _C = 1.0 Adc, I _B = 100 mAdc)	V _{CE(sat)}	-	-	0.5	Vdc	
Base-Emitter On Voltage (I _C = 1.0 Adc, V _{CE} = 1.0 Vdc)	V _{BE(on)}	-	-	1.0	Vdc	
DYNAMIC CHARACTERISTICS						
Current-Gain - Bandwidth Product (I _C = 10 mAdc, V _{CE} = 5.0 Vdc)	f _T	-	60	-	MHz	

TYPICAL ELECTRICAL CHARACTERISTICS

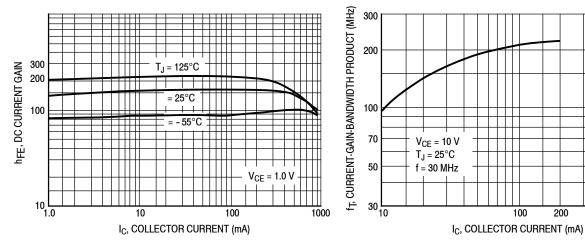


Figure 1. DC Current Gain

Figure 2. Current-Gain-Bandwidth Product

200

1000

TYPICAL ELECTRICAL CHARACTERISTICS

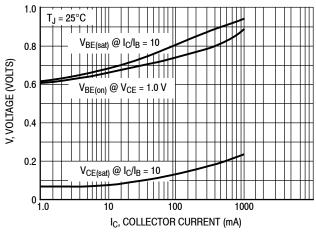


Figure 3. "On" Voltage

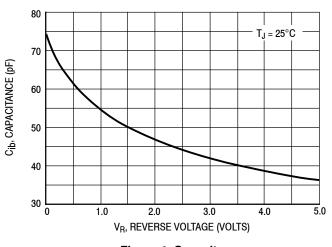


Figure 4. Capacitance

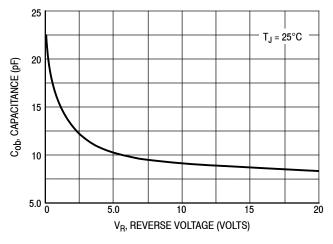


Figure 5. Capacitance

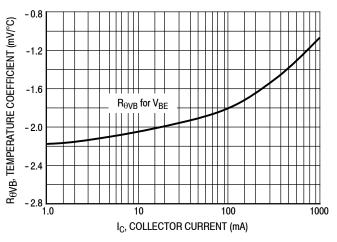


Figure 6. Base-Emitter Temperature Coefficient

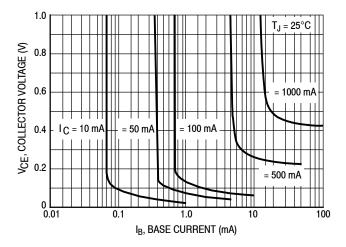
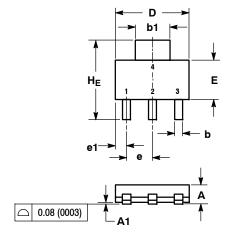
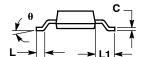


Figure 7. Saturation Region

PACKAGE DIMENSIONS

SOT-223 (TO-261) CASE 318E-04 **ISSUE N**





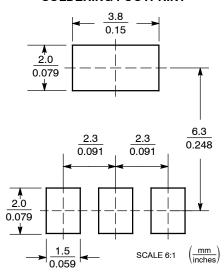
DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
CONTROLLING DIMENSION: INCH

	MILLIMETERS INCLIES					
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.50	1.63	1.75	0.060	0.064	0.068
A1	0.02	0.06	0.10	0.001	0.002	0.004
b	0.60	0.75	0.89	0.024	0.030	0.035
b1	2.90	3.06	3.20	0.115	0.121	0.126
С	0.24	0.29	0.35	0.009	0.012	0.014
D	6.30	6.50	6.70	0.249	0.256	0.263
E	3.30	3.50	3.70	0.130	0.138	0.145
е	2.20	2.30	2.40	0.087	0.091	0.094
e1	0.85	0.94	1.05	0.033	0.037	0.041
L	0.20			0.008		
L1	1.50	1.75	2.00	0.060	0.069	0.078
HE	6.70	7.00	7.30	0.264	0.276	0.287
θ	0°	-	10°	0°	-	10°

PIN 1. BASE 2. COLLI

COLLECTOR 3. EMITTER

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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